1. Description

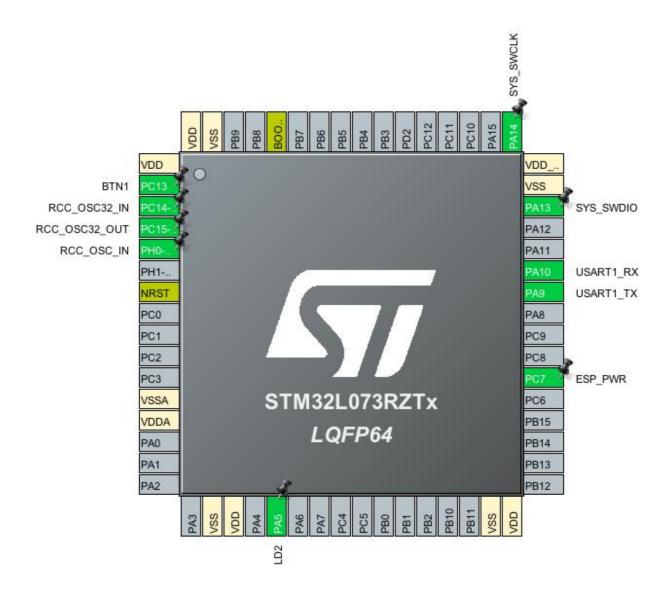
1.1. Project

Project Name	ESP_smart_home
Board Name	NUCLEO-L073RZ
Generated with:	STM32CubeMX 5.6.0
Date	03/03/2020

1.2. MCU

MCU Series	STM32L0
MCU Line	STM32L0x3
MCU name	STM32L073RZTx
MCU Package	LQFP64
MCU Pin number	64

2. Pinout Configuration

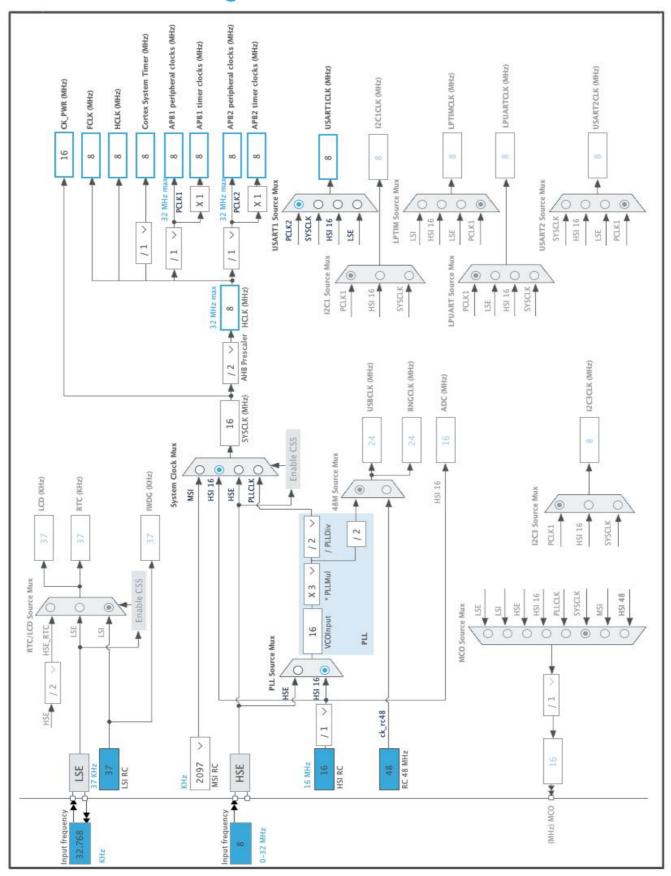


3. Pins Configuration

Pin Number LQFP64	Pin Name (function after reset)	Pin Type	Alternate Function(s)	Label
1	VDD	Power		
2	PC13	I/O	GPIO_EXTI13	BTN1
3	PC14-OSC32_IN	I/O	RCC_OSC32_IN	
4	PC15-OSC32_OUT	I/O	RCC_OSC32_OUT	
5	PH0-OSC_IN	I/O	RCC_OSC_IN	
7	NRST	Reset		
12	VSSA	Power		
13	VDDA	Power		
18	VSS	Power		
19	VDD	Power		
21	PA5 *	I/O	GPIO_Output	LD2
31	VSS	Power		
32	VDD	Power		
38	PC7 *	I/O	GPIO_Output	ESP_PWR
42	PA9	I/O	USART1_TX	
43	PA10	I/O	USART1_RX	
46	PA13	I/O	SYS_SWDIO	
47	VSS	Power		
48	VDD_USB	Power		
49	PA14	I/O	SYS_SWCLK	
60	воото	Boot		
63	VSS	Power		
64	VDD	Power		

^{*} The pin is affected with an I/O function

4. Clock Tree Configuration



5. Software Project

5.1. Project Settings

Name	Value		
Project Name	ESP_smart_home		
Project Folder	/Users/macandreas/eclipse-workspace/STM32/ESP_smart_home		
Toolchain / IDE	STM32CubeIDE		
Firmware Package Name and Version	STM32Cube FW_L0 V1.11.2		

5.2. Code Generation Settings

Name	Value
STM32Cube MCU packages and embedded software	Copy only the necessary library files
Generate peripheral initialization as a pair of '.c/.h' files	Yes
Backup previously generated files when re-generating	No
Delete previously generated files when not re-generated	Yes
Set all free pins as analog (to optimize the power	No
consumption)	

6. Power Consumption Calculator report

6.1. Microcontroller Selection

Series	STM32L0
Line	STM32L0x3
мси	STM32L073RZTx
Datasheet	027096_Rev3

6.2. Parameter Selection

Temperature	25
Vdd	3.0

6.3. Battery Selection

Battery	Li-SOCL2(AAA700)
Capacity	700.0 mAh
Self Discharge	0.08 %/month
Nominal Voltage	3.6 V
Max Cont Current	10.0 mA
Max Pulse Current	30.0 mA
Cells in series	1
Cells in parallel	1

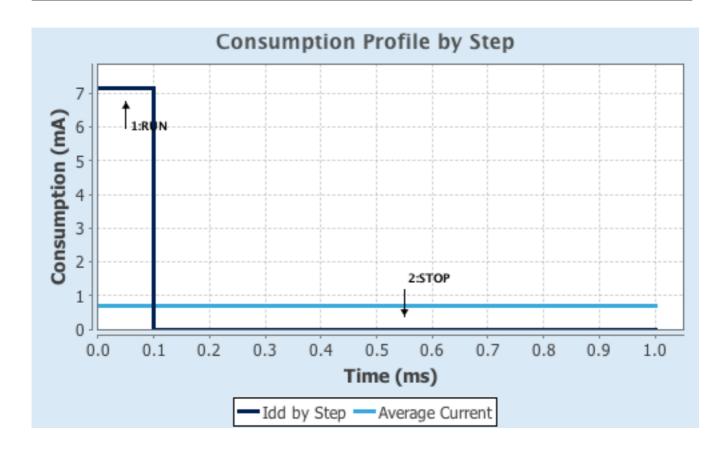
6.4. Sequence

Step	Step1	Step2
Mode	RUN	STOP
Vdd	3.0	3.0
Voltage Source	Battery	Battery
Range	Range1-High	NoRange
Fetch Type	FLASH	n/a
CPU Frequency	32 MHz	0 Hz
Clock Configuration	HSI PLL	ALL CLOCKS OFF
Clock Source Frequency	16 MHz	0 Hz
Peripherals		
Additional Cons.	0 mA	0 mA
Average Current	7.15 mA	430 nA
Duration	0.1 ms	0.9 ms
DMIPS	30.0	0.0
Та Мах	104.01	105
Category	In DS Table	In DS Table

6.5. RESULTS

Sequence Time	1 ms	Average Current	715.39 µA
Battery Life	1 month, 10 days,	Average DMIPS	30.4 DMIPS
	7 hours		

6.6. Chart



7. IPs and Middleware Configuration 7.1. GPIO

7.2. RCC

High Speed Clock (HSE): BYPASS Clock Source Low Speed Clock (LSE): Crystal/Ceramic Resonator

7.2.1. Parameter Settings:

System Parameters:

VDD voltage (V) 3.3
Buffer Cache Enabled
Prefetch Disabled
Preread Enabled

Flash Latency(WS) 0 WS (1 CPU cycle)

RCC Parameters:

HSI Calibration Value 16

MSI Calibration Value 0

HSE Startup Timout Value (ms) 100

LSE Startup Timout Value (ms) 5000

Power Parameters:

Power Regulator Voltage Scale Power Regulator Voltage Scale 1

7.3. SYS

mode: Debug Serial Wire Timebase Source: SysTick

7.4. TIM6

mode: Activated

7.4.1. Parameter Settings:

Counter Settings:

Prescaler (PSC - 16 bits value) 0
Counter Mode Up

Counter Period (AutoReload Register - 16 bits value) 65535 * auto-reload preload Disable

Trigger Output (TRGO) Parameters:

Trigger Event Selection

Reset (UG bit from TIMx_EGR)

7.5. USART1

Mode: Asynchronous

7.5.1. Parameter Settings:

Basic Parameters:

Baud Rate 115200

Word Length 8 Bits (including Parity)

Parity None Stop Bits 1

Advanced Parameters:

Data Direction Receive and Transmit

Over Sampling 16 Samples
Single Sample Disable

Advanced Features:

Auto Baudrate Disable Disable TX Pin Active Level Inversion RX Pin Active Level Inversion Disable Disable Data Inversion Disable TX and RX Pins Swapping Enable Overrun DMA on RX Error Enable MSB First Disable

* User modified value

8. System Configuration

8.1. GPIO configuration

IP	Pin	Signal	GPIO mode	GPIO pull/up pull down	Max Speed	User Label
RCC	PC14- OSC32_IN	RCC_OSC32_IN	n/a	n/a	n/a	
	PC15- OSC32_OU T	RCC_OSC32_O UT	n/a	n/a	n/a	
	PH0- OSC_IN	RCC_OSC_IN	n/a	n/a	n/a	
SYS	PA13	SYS_SWDIO	n/a	n/a	n/a	
	PA14	SYS_SWCLK	n/a	n/a	n/a	
USART1	PA9	USART1_TX	Alternate Function Push Pull	No pull-up and no pull-down	Very High *	
	PA10	USART1_RX	Alternate Function Push Pull	No pull-up and no pull-down	Very High	
GPIO	PC13	GPIO_EXTI13	External Interrupt Mode with Rising edge trigger detection	No pull-up and no pull-down	n/a	BTN1
	PA5	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	LD2
	PC7	GPIO_Output	Output Push Pull	No pull-up and no pull-down	Low	ESP_PWR

8.2. DMA configuration

DMA request	Stream	Direction	Priority
USART1_RX	DMA1_Channel3	Peripheral To Memory	Low
USART1_TX	DMA1_Channel2	Memory To Peripheral	Low

USART1_RX: DMA1_Channel3 DMA request Settings:

Mode: Normal
Peripheral Increment: Disable
Memory Increment: Enable *
Peripheral Data Width: Byte
Memory Data Width: Byte

USART1_TX: DMA1_Channel2 DMA request Settings:

Mode: Normal
Peripheral Increment: Disable
Memory Increment: Enable *

Peripheral Data Width: Byte
Memory Data Width: Byte

8.3. NVIC configuration

Interrupt Table	Enable	Preenmption Priority	SubPriority
Non maskable Interrupt	true	0	0
Hard fault interrupt	true	0	0
System service call via SWI instruction	true	0	0
Pendable request for system service	true	0	0
System tick timer	true	0	0
DMA1 channel 2 and channel 3 interrupts	true	0	0
USART1 global interrupt / USART1 wake-up interrupt through EXTI line 25	true	0	0
PVD interrupt through EXTI line 16	unused		
Flash and EEPROM global interrupt	unused		
RCC and CRS global interrupt	unused		
EXTI line 4 to 15 interrupts	unused		
TIM6 global interrupt and DAC1/DAC2 underrun error interrupts	unused		

^{*} User modified value

9. Predefined Views - Category view: Current



10. Software Pack Report